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Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	24
Program Memory Size	16KB (16K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323hah2816c00tr



Figure 34. SCLK Circuit	58
Figure 35. Stop Mode Recovery Source	59
Figure 36. Stop Mode Recovery Register 2 ((0F)DH:D2–D4, D6 Write Only) . .	61
Figure 37. Watch-Dog Timer Mode Register (Write Only)	62
Figure 38. Resets and WDT	63
Figure 39. TC8 Control Register ((0D)00H: Read/Write Except Where Noted) .	66
Figure 40. T8 and T16 Common Control Functions ((0D)01H: Read/Write) . .	67
Figure 41. T16 Control Register ((0D) 2H: Read/Write Except Where Noted) .	69
Figure 42. T8/T16 Control Register (0D)03H: Read/Write (Except Where Noted)	70
Figure 43. Voltage Detection Register	71
Figure 44. Port Configuration Register (PCON)(0F)00H: Write Only)	72
Figure 45. Stop Mode Recovery Register ((0F)0BH: D6–D0=Write Only, D7=Read Only)	73
Figure 46. Stop Mode Recovery Register 2 ((0F)0DH:D2–D4, D6 Write Only) .	74
Figure 47. Watch-Dog Timer Register ((0F) 0FH: Write Only)	75
Figure 48. Port 2 Mode Register (F6H: Write Only)	75
Figure 49. Port 3 Mode Register (F7H: Write Only)	76
Figure 50. Port 0 and 1 Mode Register (F8H: Write Only)	77
Figure 51. Interrupt Priority Register (F9H: Write Only)	78
Figure 52. Interrupt Request Register (FAH: Read/Write)	79
Figure 53. Interrupt Mask Register (FBH: Read/Write)	79
Figure 54. Flag Register (FCH: Read/Write)	80
Figure 55. Register Pointer (FDH: Read/Write)	80
Figure 56. Stack Pointer High (FEH: Read/Write)	81
Figure 57. Stack Pointer Low (FFH: Read/Write)	81
Figure 58. 20-Pin CDIP Package	82
Figure 59. 20-Pin PDIP Package Diagram	82
Figure 60. 20-Pin SOIC Package Diagram	83
Figure 61. 20-Pin SSOP Package Diagram	84
Figure 62. 28-Pin SOIC Package Diagram	85
Figure 63. 28-Pin CDIP Package Diagram	86
Figure 64. 28-Pin PDIP Package Diagram	86
Figure 65. 28-Pin SSOP Package Diagram	87
Figure 66. 40-Pin PDIP Package Diagram	87
Figure 67. 40-Pin CDIP Package Diagram	88

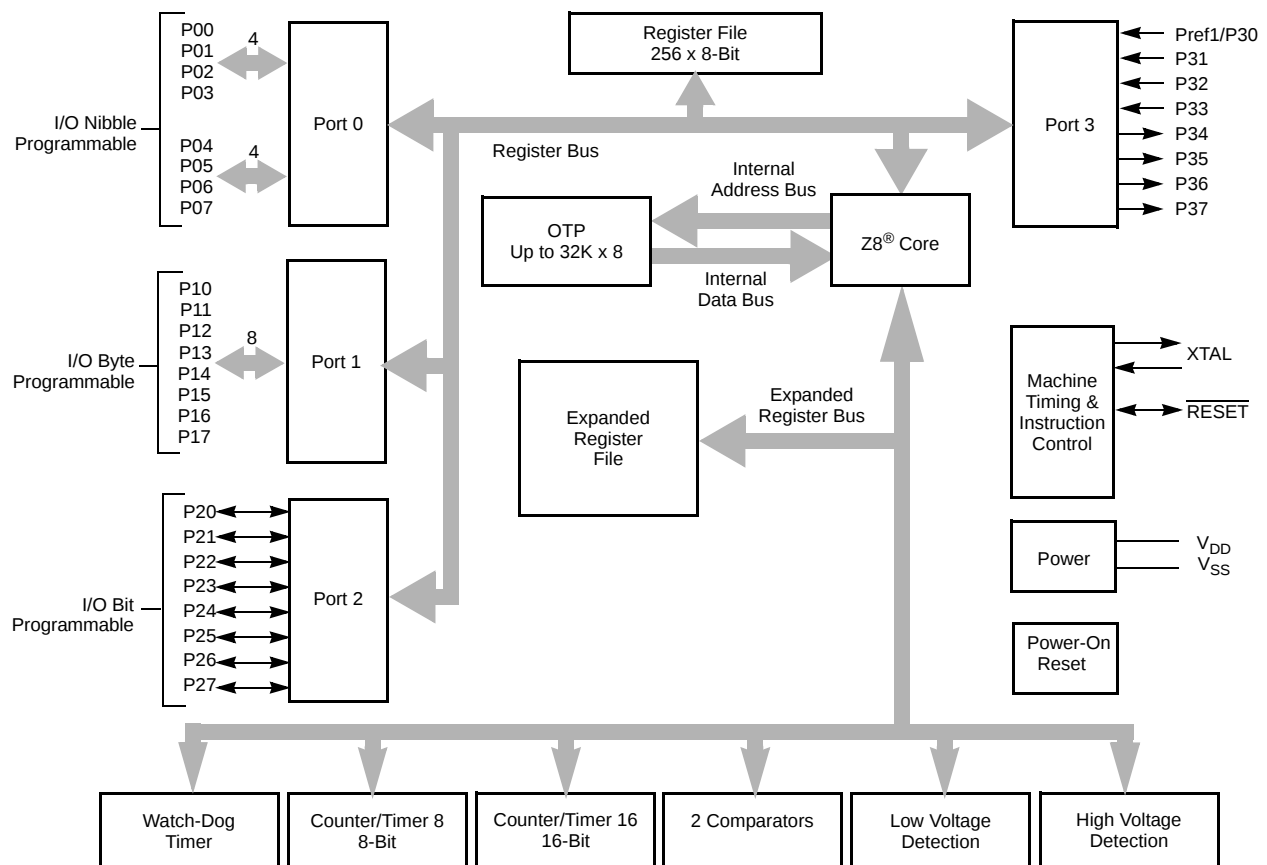


List of Tables

Table 1.	Revision History of this Document	iii
Table 2.	Features	1
Table 3.	Power Connections	3
Table 4.	20-Pin PDIP/SOIC/SSOP/CDIP* Pin Identification	5
Table 5.	28-Pin PDIP/SOIC/SSOP/CDIP* Pin Identification	6
Table 6.	40- and 48-Pin Configuration	8
Table 7.	Absolute Maximum Ratings	10
Table 8.	Capacitance	11
Table 9.	GP323HS DC Characteristics	11
Table 10.	GP323HE DC Characteristics	12
Table 11.	GP323HA DC Characteristics	14
Table 12.	EPROM/OTP Characteristics	15
Table 13.	AC Characteristics	17
Table 14.	Port 3 Pin Function Summary.	23
Table 15.	CTR1(0D)01H T8 and T16 Common Functions	35
Table 16.	Interrupt Types, Sources, and Vectors	52
Table 17.	IRQ Register	52
Table 18.	SMR2(F)0DH:Stop Mode Recovery Register 2*	58
Table 19.	Stop Mode Recovery Source	60
Table 20.	Watch-Dog Timer Time Select	63
Table 21.	EPROM Selectable Options	64

Table 3. Power Connections

Connection	Circuit	Device
Power	V _{CC}	V _{DD}
Ground	GND	V _{SS}



Note: Refer to the specific package for available pins.

Figure 1. Functional Block Diagram

Capacitance

Table 8 lists the capacitances.

Table 8. Capacitance

Parameter	Maximum
Input capacitance	12pF
Output capacitance	12pF
I/O capacitance	12pF
Note: $T_A = 25^\circ\text{C}$, $V_{CC} = \text{GND} = 0\text{V}$, $f = 1.0\text{MHz}$, unmeasured pins returned to GND	

DC Characteristics

Table 9. GP323HS DC Characteristics

Symbol	Parameter	V_{CC}	$T_A = 0^\circ\text{C to } +70^\circ\text{C}$			Units	Conditions	Notes
			Min	Typ(7)	Max			
V_{CC}	Supply Voltage		2.0		5.5	V	See Note 5	5
V_{CH}	Clock Input High Voltage	2.0-5.5	$0.8 V_{CC}$		$V_{CC}+0.3$	V	Driven by External Clock Generator	
V_{CL}	Clock Input Low Voltage	2.0-5.5	$V_{SS}-0.3$		0.4	V	Driven by External Clock Generator	
V_{IH}	Input High Voltage	2.0-5.5	$0.7 V_{CC}$		$V_{CC}+0.3$	V		
V_{IL}	Input Low Voltage	2.0-5.5	$V_{SS}-0.3$		$0.2 V_{CC}$	V		
V_{OH1}	Output High Voltage	2.0-5.5	$V_{CC}-0.4$			V	$I_{OH} = -0.5\text{mA}$	
V_{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-5.5	$V_{CC}-0.8$			V	$I_{OH} = -7\text{mA}$	
V_{OL1}	Output Low Voltage	2.0-5.5			0.4	V	$I_{OL} = 4.0\text{mA}$	
V_{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-5.5			0.8	V	$I_{OL} = 10\text{mA}$	
V_{OFFSET}	Comparator Input Offset Voltage	2.0-5.5			25	mV		
V_{REF}	Comparator Reference Voltage	2.0-5.5	0		V_{CC} 1.75	V		
I_{IL}	Input Leakage	2.0-5.5	-1		1	μA	$V_{IN} = 0\text{V}$, V_{CC} Pull-ups disabled	
R_{PU}	Pull-up Resistance	2.0V	225		675	$\text{K}\Omega$	$V_{IN} = 0\text{V}$; Pullups selected by mask option	
		3.6V	75		275	$\text{K}\Omega$		
		5.0V	40		160	$\text{K}\Omega$		

Table 9. GP323HS DC Characteristics (Continued)

Symbol	Parameter	V _{CC}	T _A =0°C to +70°C			Units	Conditions	Notes
			Min	Typ(7)	Max			
I _{OL}	Output Leakage	2.0-5.5	-1		1	μA	V _{IN} = 0V, V _{CC}	
I _{CC}	Supply Current	2.0V		1	3	mA	at 8.0 MHz	1, 2
		3.6V		5	10	mA	at 8.0 MHz	1, 2
		5.5V		10	15	mA	at 8.0 MHz	1, 2
I _{CC1}	Standby Current (HALT Mode)	2.0V		0.5	1.6	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
		3.6V		0.8	2.0	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
		5.5V		1.3	3.2	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
I _{CC2}	Standby Current (Stop Mode)	2.0V		1.6	8	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
		3.6V		1.8	10	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
		5.5V		1.9	12	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
		2.0V		5	20	μA	V _{IN} = 0 V, V _{CC} WDT is Running	3
		3.6V		8	30	μA	V _{IN} = 0 V, V _{CC} WDT is Running	3
		5.5V		15	45	μA	V _{IN} = 0 V, V _{CC} WDT is Running	3
I _{LV}	Standby Current (Low Voltage)			1.2	6	μA	Measured at 1.3V	4
V _{BO}	V _{CC} Low Voltage Protection			1.9	2.0	V	8MHz maximum Ext. CLK Freq.	
V _{LVD}	V _{CC} Low Voltage Detection			2.4		V		
V _{HVD}	V _{CC} High Voltage Detection			2.7		V		

Notes:

1. All outputs unloaded, inputs at rail.
2. CL1 = CL2 = 100 pF.
3. Oscillator stopped.
4. Oscillator stops when V_{CC} falls below V_{BO} limit.
5. It is strongly recommended to add a filter capacitor (minimum 0.1 μF), physically close to V_{CC} and V_{SS} pins if operating voltage fluctuations are anticipated, such as those resulting from driving an Infrared LED.
6. Comparator and Timers are on. Interrupt disabled.
7. Typical values shown are at 25 degrees C.

Table 10. GP323HE DC Characteristics

Symbol	Parameter	V _{CC}	T _A = -40°C to +105°C			Units	Conditions	Notes
			Min	Typ(7)	Max			
V _{CC}	Supply Voltage		2.0		5.5	V	See Note 5	5
V _{CH}	Clock Input High Voltage	2.0-5.5	0.8 V _{CC}		V _{CC} +0.3	V	Driven by External Clock Generator	
V _{CL}	Clock Input Low Voltage	2.0-5.5	V _{SS} -0.3		0.4	V	Driven by External Clock Generator	
V _{IH}	Input High Voltage	2.0-5.5	0.7 V _{CC}		V _{CC} +0.3	V		
V _{IL}	Input Low Voltage	2.0-5.5	V _{SS} -0.3		0.2 V _{CC}	V		
V _{OH1}	Output High Voltage	2.0-5.5	V _{CC} -0.4			V	I _{OH} = -0.5mA	



Table 10. GP323HE DC Characteristics (Continued)

Symbol	Parameter	V _{CC}	T _A = -40°C to +105°C			Units	Conditions	Notes
			Min	Typ(7)	Max			
V _{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-5.5	V _{CC} -0.8			V	I _{OH} = -7mA	
V _{OL1}	Output Low Voltage	2.0-5.5			0.4	V	I _{OL} = 4.0mA	
V _{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-5.5			0.8	V	I _{OL} = 10mA	
V _{OFFSET}	Comparator Input Offset Voltage	2.0-5.5			25	mV		
V _{REF}	Comparator Reference Voltage	2.0-5.5	0		V _{DD} -1.75	V		
I _{IL}	Input Leakage	2.0-5.5	-1		1	μA	V _{IN} = 0V, V _{CC} Pull-ups disabled	
R _{PU}	Pull-up Resistance	2.0V	200.0		700.0	KΩ	V _{IN} = 0V; Pullups selected by mask option	
		3.6V	50.0		300.0	KΩ		
		5.0V	25.0		175.0	KΩ		
I _{OL}	Output Leakage	2.0-5.5	-1		1	μA	V _{IN} = 0V, V _{CC}	
I _{CC}	Supply Current	2.0V		1	3	mA	at 8.0 MHz	1, 2
		3.6V		5	10	mA	at 8.0 MHz	1, 2
		5.5V		10	15	mA	at 8.0 MHz	1, 2
I _{CC1}	Standby Current (HALT Mode)	2.0V		0.5	1.6	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
		3.6V		0.8	2.0	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
		5.5V		1.3	3.2	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
I _{CC2}	Standby Current (Stop Mode)	2.0V		1.6	12	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
		3.6V		1.8	15	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
		5.5V		1.9	18	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
		2.0V		5	30	μA	V _{IN} = 0 V, V _{CC} WDT is Running	3
		3.6V		8	40	μA	V _{IN} = 0 V, V _{CC} WDT is Running	3
		5.5V		15	60	μA	V _{IN} = 0 V, V _{CC} WDT is Running	3
I _{LV}	Standby Current (Low Voltage)			1.2	6	μA	Measured at 1.3V	4
V _{BO}	V _{CC} Low Voltage Protection			1.9	2.15	V	8MHz maximum Ext. CLK Freq.	
V _{LVD}	V _{CC} Low Voltage Detection			2.4		V		
V _{HVD}	V _{CC} High Voltage Detection			2.7		V		

Notes:

1. All outputs unloaded, inputs at rail.
2. CL1 = CL2 = 100 pF.
3. Oscillator stopped.
4. Oscillator stops when V_{CC} falls below V_{BO} limit.
5. It is strongly recommended to add a filter capacitor (minimum 0.1 μF), physically close to V_{CC} and V_{SS} pins if operating voltage fluctuations are anticipated, such as those resulting from driving an Infrared LED.
6. Comparator and Timers are on. Interrupt disabled.
7. Typical values shown are at 25 degrees C.

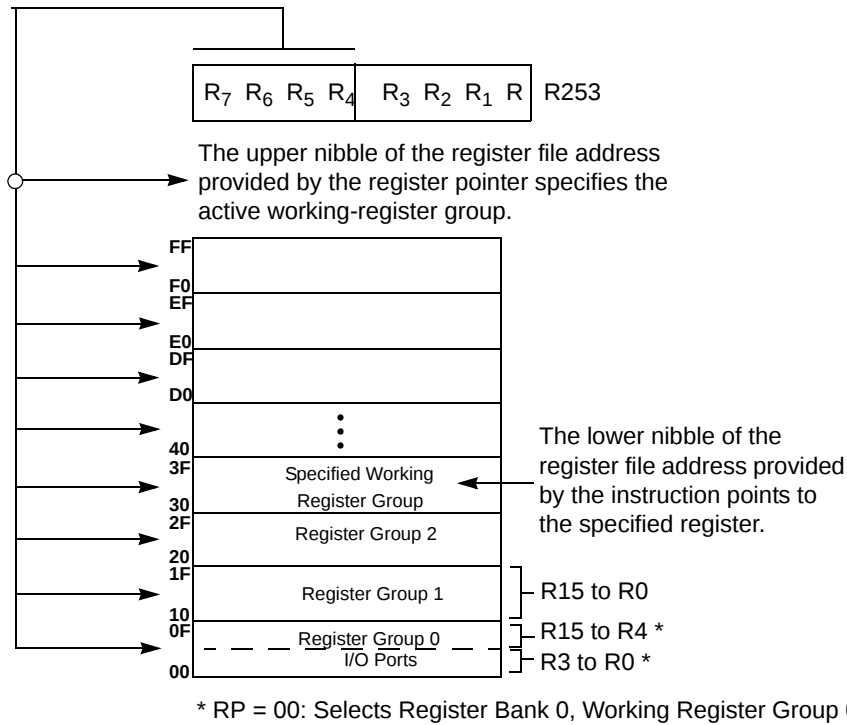


Figure 17. Register Pointer—Detail

Stack

The internal register file is used for the stack. An 8-bit Stack Pointer SPL (R255) is used for the internal stack that resides in the general-purpose registers (R4–R239). SPH (R254) can be used as a general-purpose register.

Table 16. CTR1(0D)01H T8 and T16 Common Functions (Continued)

Field	Bit Position		Value	Description
Transmit_Submode/ Glitch_Filter	----32--	R/W		Transmit Mode
			00*	Normal Operation
			01	Ping-Pong Mode
			10	T16_Out = 0
			11	T16_Out = 1
				Demodulation Mode
			00*	No Filter
			01	4 SCLK Cycle
			10	8 SCLK Cycle
			11	Reserved
Initial_T8_Out/ Rising Edge	-----1-	R/W	0*	Transmit Mode
			1	T8_OUT is 0 Initially
		R	0*	T8_OUT is 1 Initially
			1	Demodulation Mode
		W	0	No Rising Edge
			1	Rising Edge Detected
			0	No Effect
			1	Reset Flag to 0
Initial_T16_Out/ Falling Edge	-----0	R/W	0*	Transmit Mode
			1	T16_OUT is 0 Initially
		R	0*	T16_OUT is 1 Initially
			1	Demodulation Mode
		W	0	No Falling Edge
			1	Falling Edge Detected
			0	No Effect
			1	Reset Flag to 0

Note:

*Default at Power-On Reset

*Default at Power-On Reset. Not reset with Stop Mode recovery.

Mode

If the result is 0, the counter/timers are in TRANSMIT mode; otherwise, they are in DEMODULATION mode.

P36_Out/Demodulator_Input

In TRANSMIT Mode, this bit defines whether P36 is used as a normal output pin or the combined output of T8 and T16.

In DEMODULATION Mode, this bit defines whether the input signal to the Counter/Timers is from P20 or P31.

If the input signal is from Port 31, a capture event may also generate an IRQ2 interrupt. To prevent generating an IRQ2, either disable the IRQ2 interrupt by clearing its IMR bit D2 or use P20 as the input.

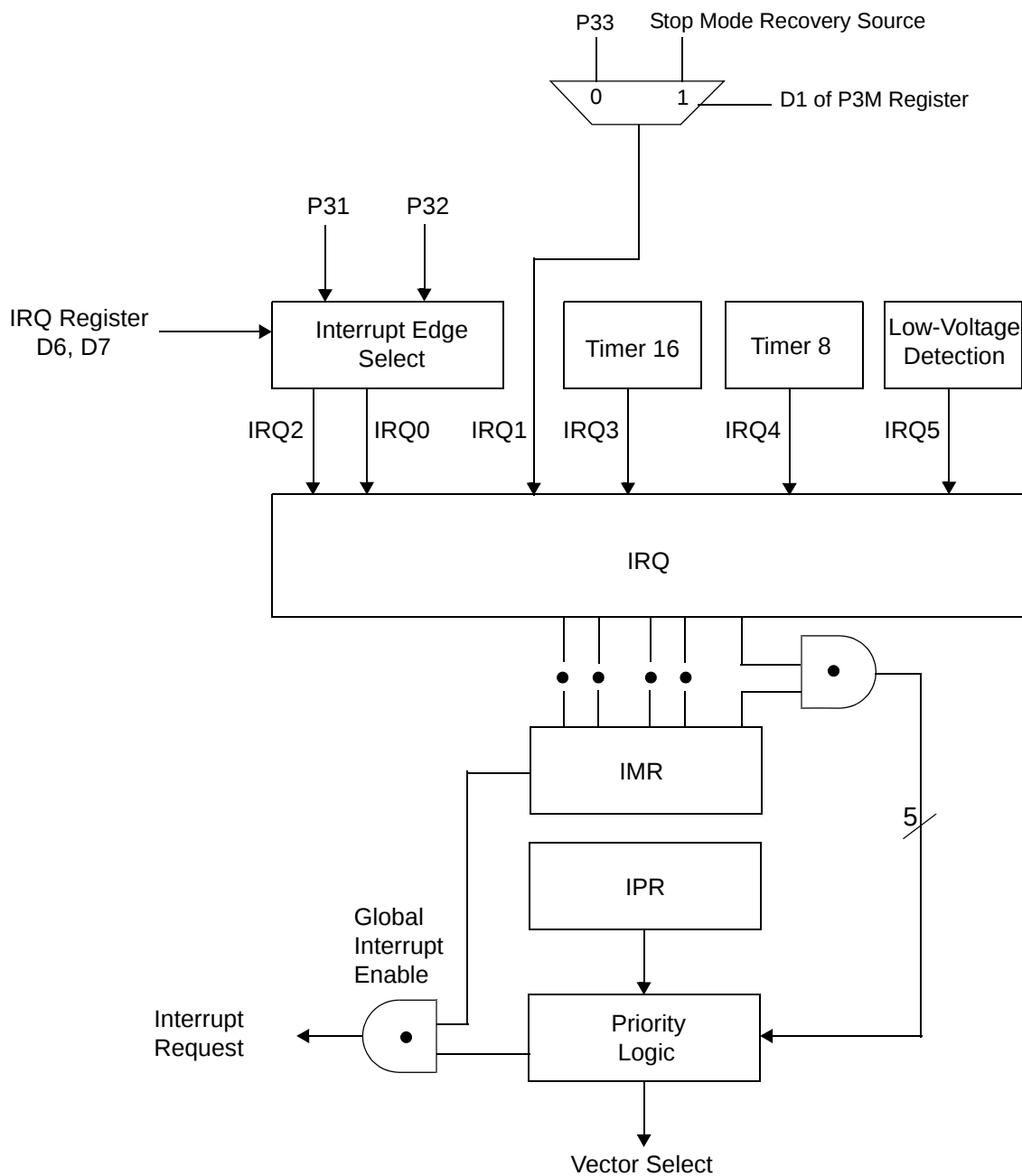


Figure 30. Interrupt Block Diagram



Port 0 Output Mode (D2)

Bit 2 controls the output mode of port 0. A 1 in this location sets the output to push-pull, and a 0 sets the output to open-drain.

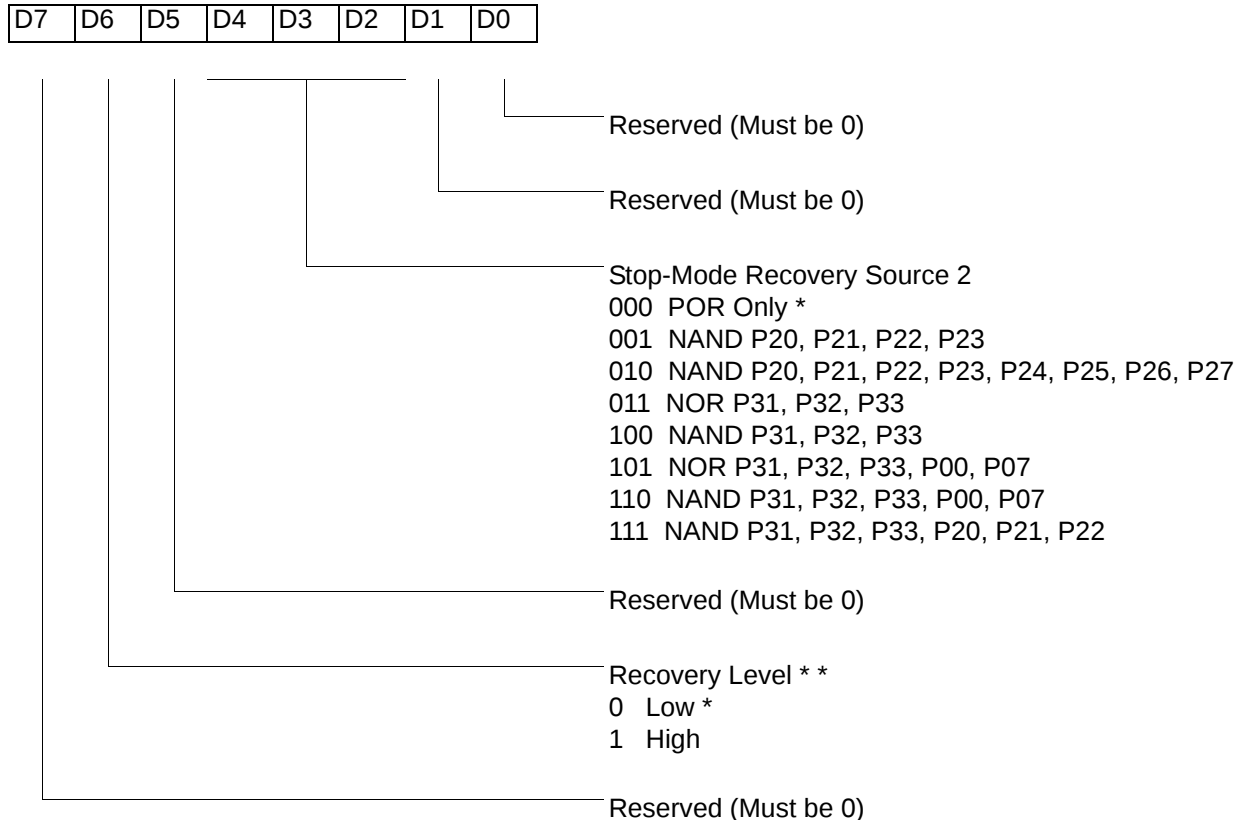
Stop-Mode Recovery Register (SMR)

This register selects the clock divide value and determines the mode of Stop Mode Recovery (Figure 33). All bits are write only except bit 7, which is read only. Bit 7 is a flag bit that is hardware set on the condition of Stop recovery and reset by a power-on cycle. Bit 6 controls whether a low level or a high level at the XOR-gate input (Figure 35 on page 59) is required from the recovery source. Bit 5 controls the reset delay after recovery. Bits D2, D3, and D4 of the SMR register specify the source of the Stop Mode Recovery signal. Bits D0 determines if SCLK/TCLK are divided by 16 or not. The SMR is located in Bank F of the Expanded Register Group at address 0BH.

Stop Mode Recovery Register 2 (SMR2)

This register determines the mode of Stop Mode Recovery for SMR2 (Figure 36).

SMR2(0F)DH



Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.

* Default setting after reset

* * At the XOR gate input

Figure 36. Stop Mode Recovery Register 2 ((0F)DH:D2–D4, D6 Write Only)

If SMR2 is used in conjunction with SMR, either of the specified events causes a Stop Mode Recovery.

► **Note:** Port pins configured as outputs are ignored as an SMR or SMR2 recovery source. For example, if the NAND or P23–P20 is selected as the recovery source and P20 is configured as an output, the remaining SMR pins (P23–P21) form the NAND equation.

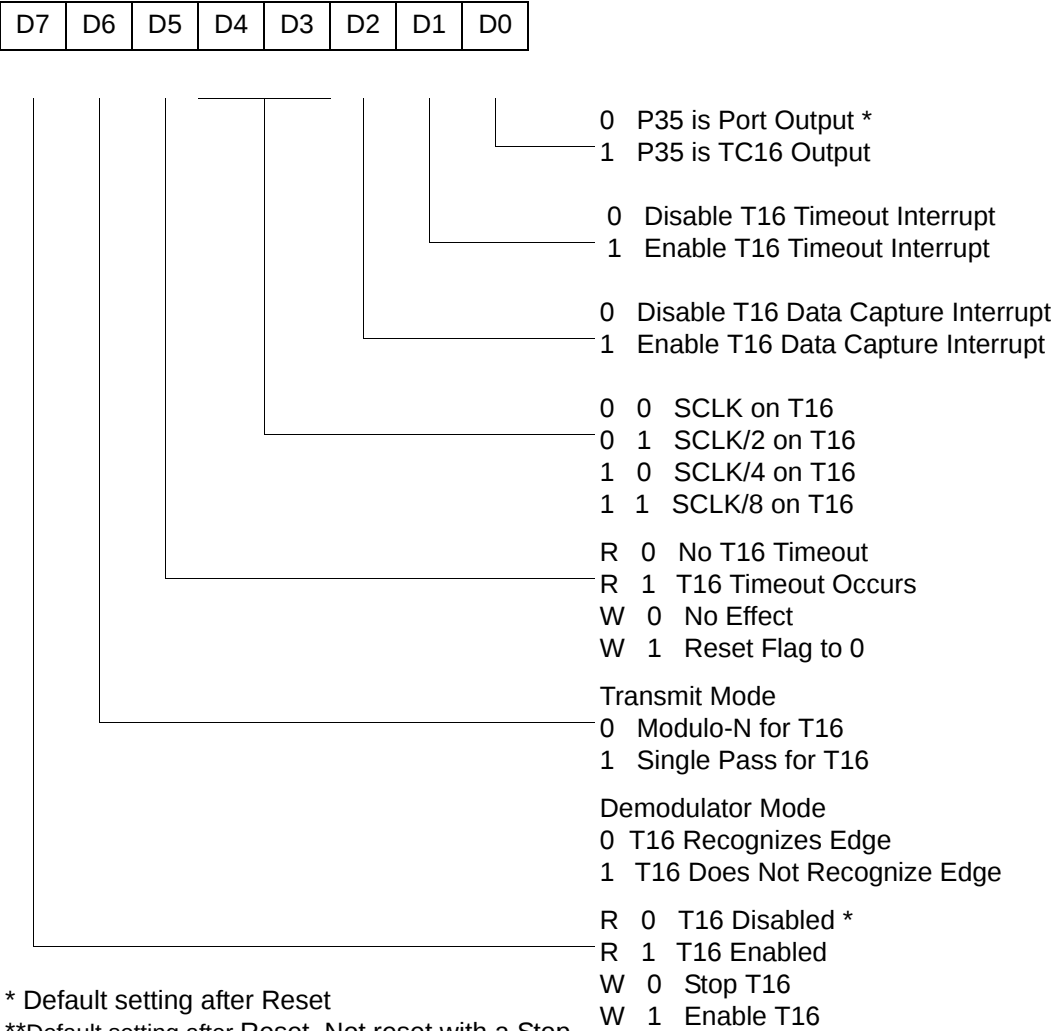


- **Notes:** Take care in differentiating the Transmit Mode from Demodulation Mode. Depending on which of these two modes is operating, the CTR1 bit has different functions.

Changing from one mode to another cannot be performed without disabling the counter/timers.



CTR2(0D)02H

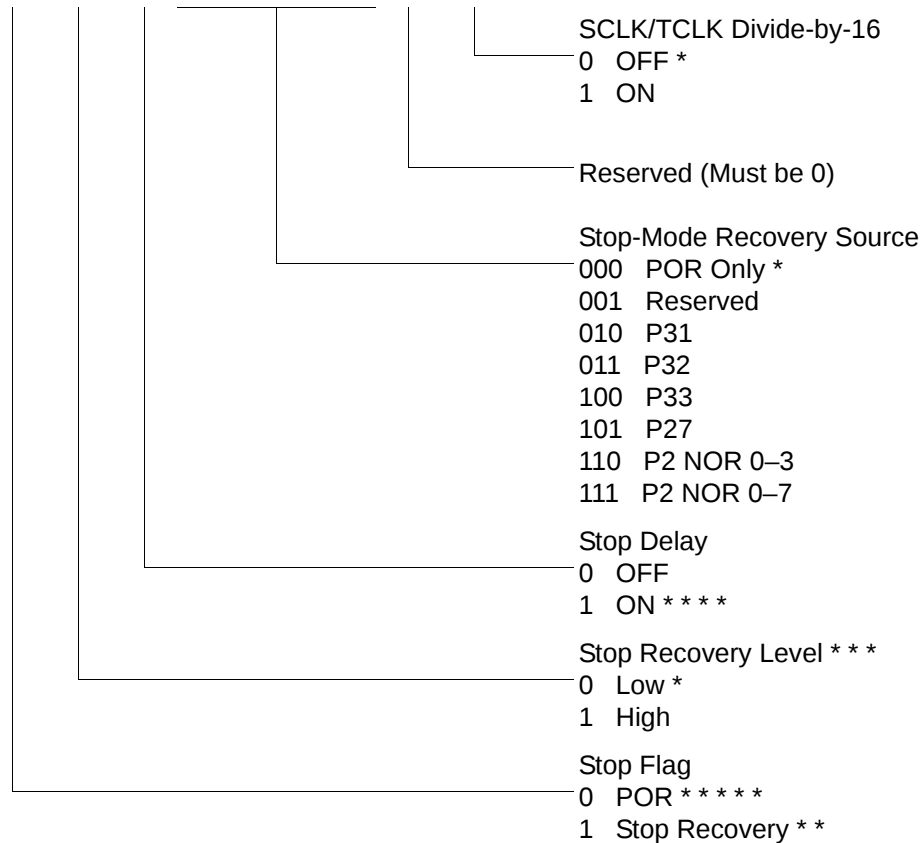


* Default setting after Reset
**Default setting after Reset. Not reset with a Stop-Mode recovery.

Figure 41. T16 Control Register ((0D) 2H: Read/Write Except Where Noted)

SMR(0F)0BH

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



* Default setting after reset

* * Set after Stop Mode Recovery

* * * At the XOR gate input

* * * * Default setting after reset. Must be 1 if using a crystal or resonator clock source.

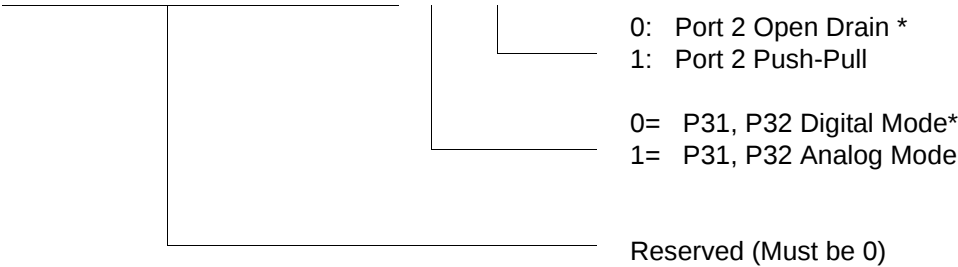
* * * * * Default setting after Power On Reset. Not reset with a Stop Mode recovery.

Figure 45. Stop Mode Recovery Register ((0F)0BH: D6–D0=Write Only, D7=Read Only)



R247 P3M(F7H)

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



* Default setting after reset. Not reset with a Stop Mode recovery.

Figure 49. Port 3 Mode Register (F7H: Write Only)



R252 Flags(FCH)

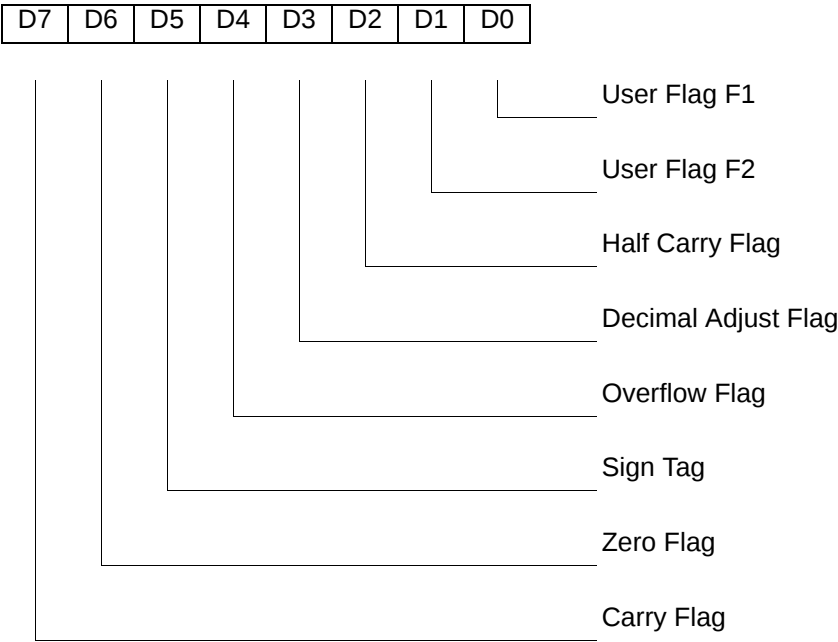
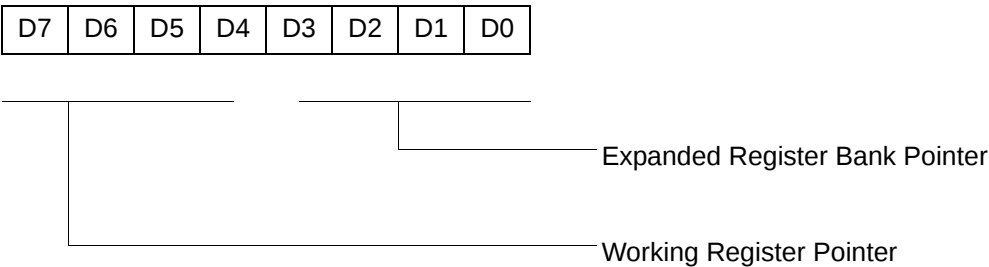


Figure 54. Flag Register (FCH: Read/Write)

R253 RP(FDH)



Default setting after reset = 0000 0000

Figure 55. Register Pointer (FDH: Read/Write)

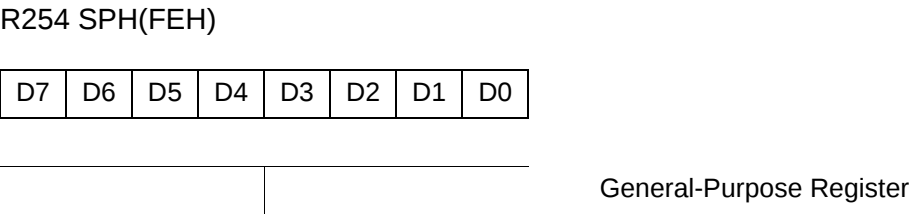


Figure 56. Stack Pointer High (FEH: Read/Write)

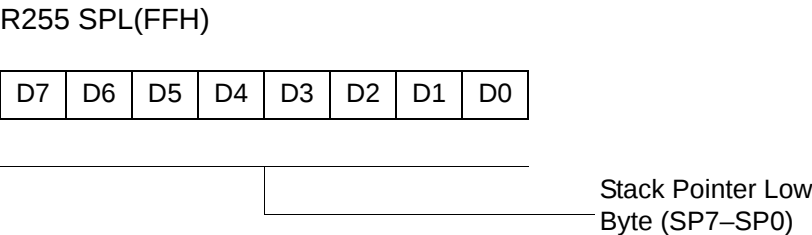
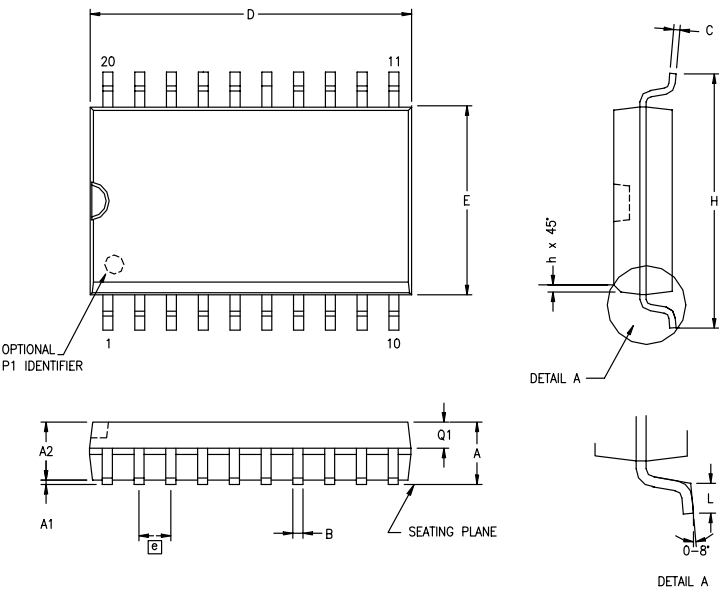


Figure 57. Stack Pointer Low (FFH: Read/Write)

Package Information

Package information for all versions of ZGP323H is depicted in Figures 59 through Figure 68.



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	2.40	2.65	.094	.104
A1	0.10	0.30	.004	.012
A2	2.24	2.44	.088	.096
B	0.36	0.46	.014	.018
C	0.23	0.30	.009	.012
D	12.60	12.95	.496	.510
E	7.40	7.60	.291	.299
⌀	1.27 BSC		.050 BSC	
H	10.00	10.65	.394	.419
h	0.30	0.40	.012	.016
L	0.60	1.00	.024	.039
Q1	0.97	1.07	.038	.042

CONTROLLING DIMENSIONS : MM
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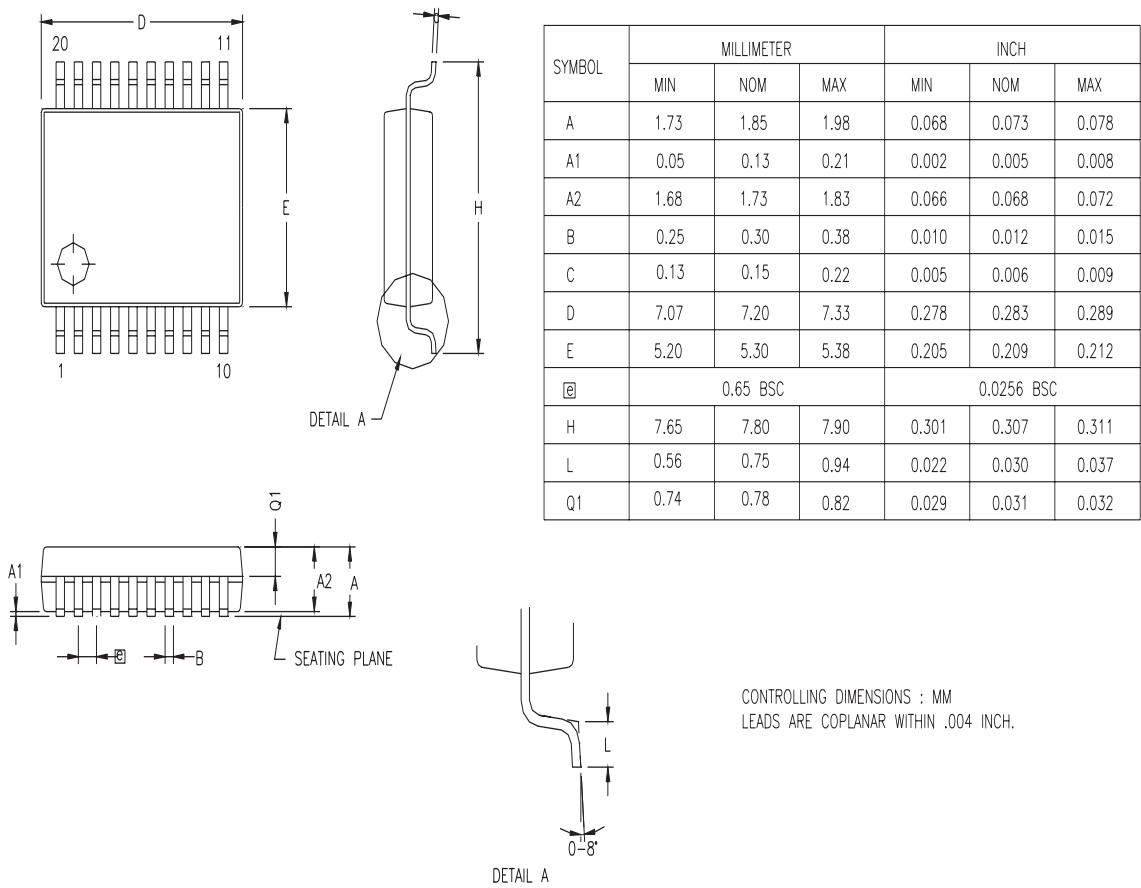


Figure 61. 20-Pin SSOP Package Diagram

- pin 4
- E
- EPROM
 - selectable options 64
- expanded register file 26
- expanded register file architecture 28
- expanded register file control registers 71
 - flag 80
 - interrupt mask register 79
 - interrupt priority register 78
 - interrupt request register 79
 - port 0 and 1 mode register 77
 - port 2 configuration register 75
 - port 3 mode register 76
 - port configuration register 75
 - register pointer 80
 - stack pointer high register 81
 - stack pointer low register 81
 - stop-mode recovery register 73
 - stop-mode recovery register 2 74
 - T16 control register 69
 - T8 and T16 common control functions register 67
 - T8/T16 control register 70
 - TC8 control register 66
 - watch-dog timer register 75
- F
- features
 - standby modes 1
- functional description
 - counter/timer functional blocks 40
 - CTR(D)01h register 35
 - CTR0(D)00h register 33
 - CTR2(D)02h register 37
 - CTR3(D)03h register 39
 - expanded register file 26
 - expanded register file architecture 28
 - HI16(D)09h register 32
 - HI8(D)0Bh register 32
 - L08(D)0Ah register 32
 - L0I6(D)08h register 32
 - program memory map 26
 - RAM 25
 - register description 65
 - register file 30
 - register pointer 29
 - register pointer detail 31
 - SMR2(F)0D1h register 40
 - stack 31
 - TC16H(D)07h register 32
 - TC16L(D)06h register 33
 - TC8H(D)05h register 33
 - TC8L(D)04h register 33
- G
- glitch filter circuitry 40
- H
- halt instruction, counter/timer 54
- I
- input circuit 40
- interrupt block diagram, counter/timer 51
- interrupt types, sources and vectors 52
- L
- low-voltage detection register 65
- M
- memory, program 25
- modulo-N mode
 - T16_OUT 47
 - T8_OUT 43
- O
- oscillator configuration 53
- output circuit, counter/timer 49
- P
- package information
 - 20-pin DIP package diagram 82
 - 20-pin SSOP package diagram 84
 - 28-pin DIP package diagram 86
 - 28-pin SOIC package diagram 85
 - 28-pin SSOP package diagram 87
 - 40-pin DIP package diagram 87
 - 48-pin SSOP package diagram 89
- pin configuration
 - 20-pin DIP/SOIC/SSOP 5